Ultra-low sintering temperature ceramic composites of CuMoO$_4$ through Ag$_2$O addition for microwave applications

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Abstract

The present paper presents ceramic composites with ultralow sintering temperature of 500 °C with densification of 96 % by adding small amount (0.5, 1 and 2 wt.%) of Ag$_2$O to CuMoO$_4$ by simple mixing method. The effect of Ag$_2$O addition on the structure, microstructure, sintering and thermal as well as microwave dielectric properties of CuMoO$_4$ is also studied. The reduction in the sintering temperature is due to the formation of trace amount (1.4%) of copper silver molybdate (Cu$_2$Ag$_2$(MoO$_4$)$_3$) as observed from Rietveld refinement analysis as well as backscattered SEM image. Doping has very little influence on the structure and coefficient of thermal expansion that is about 4.7-5.2 ppm/°C. The composites sintered at 500 °C exhibit relative permittivity of about 8-9, quality factor (Qf) of 26000-37000 GHz at 12 GHz, temperature coefficient of resonant frequency of -31-33 ppm/°C and are compatible with Al electrode. The present work results in obtaining well-densified ultralow temperature cofired ceramic composites at low sintering temperature without much structural change and good thermal properties but with different dielectric properties by small doping. These composites can be used as low cost candidates for wide range of microwave applications like multilayer packages and substrates owing to the low energy required during processing and hence can pave way to the advancement of electronic materials.

Keyword: A. Ceramic-matrix composites (CMCs), B. Electrical properties, E. Sintering, Ultra low temperature cofired ceramics

Introduction
New advancements in materials, integration, packaging and interconnection technologies demand the miniaturization of millimetre wave components for wireless communication. In this application area, materials with feasible component permittivity, low dielectric loss (high Qf value), near-zero temperature coefficient, low sintering temperature below the melting points of the electrode metals, and chemical compatibility are required. A major option was the Low-Temperature Cofired Ceramic (LTCC) technology, which has gained increased attention in the research community due to its potential to fabricate novel multilayer modules involving the integration of passive components [1-11]. In the past 20 years, a significant number of ceramics with good microwave dielectric properties have been developed for LTCC applications [3]. The today’s demand for energy saving, nontoxicity, and low cost limits the number of materials available for many practical applications.

In recent ten years or so, Ultra-Low Temperature Co-fired Ceramic (ULTCC) technology has been the focus of research as it can satisfy the urge of energy saving and reducing material wastage required by modern communication industry. In this technology, the targeted processing temperatures are below 700 °C, which enables the use of aluminium and nanosilver pastes as the inner electrodes. ULTCC materials with excellent dielectric properties and low sintering temperature have fascinated much attention due to its potential for numerous packaging and functional applications [12-14]. There are several ways to formulate microwave dielectric ceramics with ultra-low sintering temperature. The approaches used for LTCCs like utilization of low melting glass, low melting oxides, or small amounts of glass and metal oxides as sintering aids can be employed [12, 15,16].

Compositions like K$_2$Mo$_3$O$_{10}$ [17], 2Na$_2$O-MoO$_3$ composite [18], Li$_3$FeMo$_3$O$_{12}$ [19], Li$_8$Bi$_2$Mo$_7$O$_{28}$ [20], Te$_2$Mo$_{0.95}$W$_{0.05}$O$_7$ [21], Pb$_2$WO$_5$ [22], Li$_3$BiMo$_3$O$_{12}$ [20], Li$_{0.5}$Ce$_{0.5}$MoO$_4$ [23], (RbBi)$_{0.5}$MoO$_4$ [24], BaTe$_4$O$_4$+40 wt.% TiTe$_2$O$_8$ [25], (AgBi)$_{0.5}$(MoW)$_{0.5}$O$_4$ [26], (AgBi)$_{0.5}$WO$_4$ [27], and (LiBi)$_{0.5}$MoO$_4$ [20] have the sintering temperature in the range of 500-600 °C, the relative permittivity ($\varepsilon_r$) of 5.6-45, the quality factor (Qf) of 300-36 000 GHz and the temperature coefficient of resonant frequency ($\tau_f$) of -115 to 228 ppm/°C have been reported. However, the ULTCC ceramics with good microwave
properties are limited in number so far and from the practical applications point of view, further research is needed. Compositions with different relative permittivity but about the same sintering temperature are in great demand for multilayer applications. A simple and useful approach to obtain material with desired properties is by composite approach, which is widely utilized for many applications [28-42].

In our recent research, it was found that CuMoO$_4$ ceramic attained high density (96 %) with a moderately low sintering temperature of 650 $^\circ$C. It exhibits excellent microwave and thermal properties with the relative permittivity ($\varepsilon_r$) of 8, quality factor (Qf) of 53 000 GHz, temperature coefficient of relative permittivity ($\tau_{\varepsilon}$) = 63 ppm/$^\circ$C and temperature coefficient of resonant frequency ($\tau_f$) = -36 ppm/$^\circ$C at 12.7 GHz. Moreover, CuMoO$_4$ showed low coefficient of thermal expansion of 4.6 ppm/$^\circ$C, which is close to semiconductor silicon (4 ppm/$^\circ$C) forming an additional advantage in the case of device level integration [43]. In addition to this, CuMoO$_4$ is also reported as a thermochromic and piezochromic ceramic as it displays a distinct reversible change in colour at around 200 K at ambient pressure and room temperature for a pressure of 250 MPa due to the structural rearrangement leading two distinct allotropic forms of $\alpha$ and $\gamma$ [44-50]. Such chromic materials can find applications as user-friendly temperature and pressure indicators especially in safety improvement, medical, shock detector and packaging, etc. However even lower sintering temperature would be beneficial for decreasing the fabrication cost, saving energy and enabling seamless integration with temperature sensitive components and substrates. Hence, the present research focus on an attempt to lower its sintering temperature by using Ag$_2$O. Ag$_2$O was chosen due to its low melting point and has been successfully used earlier as a sintering aid in reducing the sintering temperature for ceramics like SrBi$_2$Nb$_2$O$_9$ and Pb(ZrTi)O$_3$ [51-53]. Ag$_2$O owing to its low decomposition temperature can results in obtaining a low melting compound on reaction of Ag with CuMoO$_4$. Hence can reduce the sintering temperature of CuMoO$_4$ as compounds having silver molybdates are reported to exhibit low sintering temperature with good dielectric properties [26, 54,
By combining these two ingredients, we anticipate in obtaining a composite of ultra-low sintering temperature with feasible dielectric and thermal properties. The effect of Ag$_2$O addition on densification of CuMoO$_4$ is studied along with related structural and dielectric properties investigations. Furthermore, the compatibility of Al as an electrode material for Ag$_2$O modified CuMoO$_4$ is studied which is more specifically suitable for cost effective microwave applications.

**Experimental**

CuMoO$_4$ (CMO) ceramics was prepared by a solid-state oxide-mixing route from high purity oxides of CuO and MoO$_3$ (> 99 %, Alfa Aesar). The starting materials were weighed in stoichiometric amounts and ball milled in an absolute ethanol medium with yttria-stabilized zirconia (YSZ) balls for 24 hrs. The mixture was dried and calcined at 550°C for 12 hrs followed by further ball milling for 16 hrs to obtain powders with uniform particle size. Ag$_2$O (99+%, Alfa Aesar) with the amounts of 0.5, 1 and 2 wt.% were weighed and mixed with CMO in ethanol medium. Cylindrical disks were pressed (diameter 10 mm and thickness 5 mm) with 25 MPa and sintered in the temperature range of 350 - 550 °C for microwave measurements and microstructural studies.

The crystal structure of the powders was examined by X-ray diffractometer (D8, Bruker, Billerica, MA) using Cu Kα radiation while the slow scan X-ray diffraction of the powder was examined by X-ray diffractometer (Rigaku Smart Lab 9 kW, Germany) with scan rate of 0.01 using Co Kα radiation. The microstructure of the samples were characterized by scanning electron microscopy (FESEM, ZEISS Ultra Plus, Germany) and the bulk densities of the sintered samples by Archimedes method. The coefficient of thermal expansion (CTE) in the temperature range of 25-300°C was performed with dilatometer (NETZSCH, DIL 402 PC/4, Germany) using cylindrical samples (diameter 8 mm and length 15 mm) at a heating rate of 5 °C/min. The relative permittivity ($\varepsilon_r$) and quality factor were measured using Hakki Coleman and cavity method connected to a vector network analyser (10 MHz-20 GHz, ROHDE& SCHWARZ, ZVB20, Germany). The temperature coefficient of the resonant frequency ($\tau_f$) in the temperature range of 25-85 °C was examined using cavity method with a
temperature chamber (SU-261, ESPEC CORP., Japan) and calculated using the equation 1, while temperature coefficient of relative permittivity ($\tau_\varepsilon$) is calculated using equation 2 as shown below

$$\tau_f = \frac{f_{85} - f_{25}}{f_{25} \cdot (85-25)} \times 10^{-6} \text{ ppm/}^\circ\text{C} \quad (1) \quad [56, 57]$$

$$\tau_\varepsilon = -2(\tau_f + \alpha_L) \text{ ppm/}^\circ\text{C} \quad (2) \quad [58]$$

where $\alpha_L$ is the linear thermal expansion coefficient of the dielectric sample, $\tau_\varepsilon$ is the temperature dependence of the relative permittivity, and the $\tau_f$ is the resonance frequency of the sample at different temperatures.

Bosman and Havinga’s correction [59] for the relative permittivity was calculated using the equation 3 for the porosity corrected relative permittivity, where $P$ is the porosity of the dielectric sample

$$\varepsilon_{corrected} = \varepsilon_{measured} \times (1 + 1.5P) \quad (3)$$

**Results and discussion**

Figure 1 depicts the X-ray powder diffraction pattern (XRPD) of pure and Ag$_2$O (0.5, 1 and 2 wt.%) added CMO sintered at 500 ℃. All the peaks of pure CMO in the XRPD pattern is indexed based on CMO reported in the standard ICDD file card no: 073-0488 and 04-009-2226. It is also evident that the peak positions in the XRPD pattern of pure and doped CMO closely coincide, which indicate that this small doping of Ag$_2$O does not cause any noticeable alterations in the main crystal structure. In order to confirm the structure, a slow scan XRPD is carried out for 0.5 wt% of Ag$_2$O added CMO followed by Rietveld refinement using PDXL2 (Analysis incl. Rietveld). Figure 2 (a) shows the Rietveld refinement results of 0.5 wt.% Ag$_2$O added CMO sintered at 500 ℃. The crystal structure of CMO is taken as starting model for Rietveld refinement as there is no observable changes in the structure by doping (figure 1) and all peaks are indexed by triclinic structure (P-1(2)) of CMO. The peaks are clearly visible in the XRPD pattern compared to the figure 1, due to the slow scan rate used for the characterization. The refinement was stable with low R-factors as shown in figure 2 (b). The refinement results reveal that the major phase of about 98.6 % (qualitative value) is CuMoO$_4$ and the
remaining 1.4 % (qualitative value) is that of secondary phase Cu$_2$Ag$_2$(MoO$_4$)$_3$ (ICDD File Card No: 01-078-2590). Table 1 shows the lattice parameters of major CuMoO$_4$ phase while that of the secondary phase is not given as it may not be precise owing to its weak XRPD peaks. The copper silver molybdate (Cu$_2$Ag$_2$(MoO$_4$)$_3$) (ICDD File Card No: 01-078-2590) has peaks at 2θ of 25.2, 25.5, 31.6 and 33.1°, which coincides with the peaks of CMO and are indexed in the figure 1. It is difficult to analyse the secondary phase due to the low concentration and hence further investigation is needed. The presence of secondary phase is also observed from backscattered electron image shown in figure 2 (c). The silver oxide may melt at around 300 °C and forms metallic silver which may react with the matrix to form the compound of copper silver molydate. During sintering at 500 °C and above, the new phase melted as observed from the SEM image, which further point out that it has low melting temperature of below 500 °C and hence may assist in the densification of the CMO. Similar observations were also reported [60-62].

Figure 3 shows the bulk density and densification of CMO composite ceramics as a function of the sintering temperature. The densification is calculated by comparing the bulk density of the composite to that of pure CMO ceramic, as it is difficult to obtain the theoretical density of the composite. The CMO composite ceramics exhibit an increase in density as the sintering temperature increases from 350 to 500 °C and remains almost constant at 500 °C. Moreover, the density also slightly increases with dopant concentration. This may be due to the presence of an additional phase as observed from figure 2. The densification also follows similar behaviour with increase in sintering temperature. Densification of 96 % is achieved for CMO ceramic by 0.5 wt.% addition of Ag$_2$O after sintering at 500 °C, being 150 °C lower than that for the pure CMO [43]. Further sintering at 550 °C results only in slightly improved densification. Similar results are obtained for 1 and 2 wt.% Ag$_2$O added samples and the achieved densifications are 96.3 % and 96.8 %, respectively at 500 °C. The reduction of sintering temperature may be due to the formation of trace amount of low melting compound, which enhances the densification rate at lower temperature [60-62]. Therefore, addition of Ag$_2$O can
promote faster grain growth that results in good densification at lower temperature. The conclusions according to the density measurements show that the preferred sintering temperature of the \( \text{Ag}_2\text{O} \) doped CMO ceramic is 500 °C.

The secondary electron images of the polished and thermally etched surface of the CMO composite ceramics after sintering at 450 °C, 500 °C and 550 °C are shown in figure 4. These images provide a good insight to the densification of CMO ceramic with \( \text{Ag}_2\text{O} \) addition in the sintering temperature range of 450-500 °C. The microstructure of the \( \text{Ag}_2\text{O} \) added CMO ceramics (0.5, 1 and 2 wt.%) sintered at 450 °C shown in figure 4 (a, b and c) exhibits some porosity which is in agreement with its densification values of 81, 85 and 87 % respectively. Further increase in sintering temperature to 500 °C (figure 4 d, e and f) results in much denser microstructure with almost uniform grains. SEM images of the sintered samples at 550 °C given in figure 4 (g, h and i) exhibit not much improvement in the densification. The microstructure of 0.5 wt.% of \( \text{Ag}_2\text{O} \) doped sample shows more uniform and homogeneous grains compared to the other doping levels. In general, the average grain size of the samples shows some increase in dopant concentration. It may be due to the rapid grain growth facilitated by the increase in \( \text{Ag}_2\text{O} \) content with results in more non-uniform grains owing to the formation of low melting new phase [63].

The measured CTE values (figure 5) of the CMO composite ceramics sintered at 500 °C in the temperature range of 25-300 °C are in the range of 4.7-5.2 ppm /°C. This value being very close to the CTE value of Si, makes this composition interesting substrate for device level practical applications. The CTE slightly increases with increase in \( \text{Ag}_2\text{O} \) concentration and may be due to the contribution of the new phase formed.

The relative permittivity and Qf of CMO composite ceramics as a function of sintering temperature from 350 °C to 550 °C at about frequency of 12 GHz is presented in figure 6. As the sintering temperature is increased from 350 °C to 550 °C, both relative permittivity and Qf values also increased as expected. The rise is tremendous up to sintering temperature of 500 °C and further sintering to 550
°C results only in a slight increase. These results are well in line with the density measurements and microstructure observed. It is also clear from the SEM images (figure 4) that there is an increase in the densification on increasing the temperature from 450 to 500 °C, and not much improvement at 550 °C. The relative permittivity increases from 3.8 to 8 with rise in sintering temperature from 350 °C to 500 °C and increases to 8.2 at 550 °C for 0.5 wt.% of Ag₂O added CMO. Similarly for 1 wt.% of Ag₂O added CMO, the relative permittivity changes from 3.8 to 8.3 for the same increase of temperature to 500 °C and became 8.5 at 550 °C. In the case of 2 wt.% of Ag₂O added CMO, the increase of relative permittivity is from 4.1 to 8.8 and then to 9.1 for the same sintering temperature increase. The porosity corrected value of relative permittivity for the 0.5, 1 and 2 wt.% of Ag₂O added samples sintered at 500 °C is 8.5, 8.8 and 9.2 respectively. The slight difference in the permittivity values of these composites can be accounted to their small difference in their densification (figure 3) as well as due to the presence of the new phase as evident from the SEM image (figure 2). Similar trend is followed in the variation of the Qf with temperature. For 0.5, 1 and 2 wt.% of Ag₂O added CMO, the Qf increases from 37000 to 39000 GHz, 32000 to 34000 GHz and 27000 to 28000 GHz, respectively, when the sintering temperature is increased from 500 °C to 550 °C. The small increase in both relative permittivity and Qf with an increase in sintering temperature above 500 °C may be due to the slight change in densification, which is clearly evident figure 3 and microstructure images (figure 4). Furthermore, the relative permittivity slightly increases while Qf decreases with increase in Ag₂O concentration in the CMO. It may corresponds to the Ag₂O addition due to the presence of small amount of new phase (copper silver molybdate) as evident from figure 2. The quality factor depends on many factors such a densification, pores, grain sizes/boundaries, and secondary phases etc. The grains appeared to be more uniform and homogeneous for 0.5 wt.% of Ag₂O doped sample, while growth is observed to be non-uniform with increase in dopant concentration as clear from the figure 4. The non-uniform grains due to the rapid grain growth with increase in dopant concentration may also account for the decrease in Qf value [63]. Further investigation is needed to know about the
dielectric properties of the new phase, as it is not well studied. Dielectric and structural properties of Li$_2$(M$^{2+}$)$_2$Mo$_3$O$_{12}$ (M$=$ An, Ca,In) ceramics with lyonsite related structures having ultra-low sintering temperature are reported while dielectric properties of copper silver molybdate is not reported [64]. The silver molybdate is reported to have $\varepsilon_r$ of 8.1 and Qf of 17,000 GHz [65]. All the above observations indicate that the CMO-Cu$_2$Ag$_2$(MoO$_4$)$_3$ composite ceramics can be well sintered at 500 °C with good densification and microwave dielectric properties.

The temperature dependence of microwave dielectric properties of the ceramics is critical for practical applications. The resonant frequency of the CMO composite ceramics sintered at 500°C measured in the temperature range of 25°C to 85°C is shown in figure 7. As the temperature is increased from 25 °C to 85 °C, the resonant frequency slightly decreased linearly for 0.5, 1 and 2 wt.% of Ag$_2$O added CMO. Hence, the CMO-Cu$_2$Ag$_2$(MoO$_4$)$_3$ composite ceramics exhibit $\tau_f$ in the range of -31 to -33 ppm/°C. The $\tau_e$ is calculated from $\tau_f$ and CTE values using equation 2 and is found to be in the range of 52-56 ppm/°C. The compatibility of Al as a material for electrodes with the CMO composite ceramics can be analysed by the XRPD and backscattered electron images of the cofired samples shown in figure 8. The XRPD (figure 8 a) shows peaks only related to CMO and Al which indicate that no interaction occurs between the ceramic and Al. The peaks of Al have higher intensity and may be due to the presence of 50 wt.% of Al metal, which is having large particle size that of matrix. SEM images of the cofired samples (figure 8 (b)) exhibit only two different type of grains where the darker grains belong to Al metal while the lighter one to matrix. Hence, Al metal can be used as an electrode for the CMO-Cu$_2$Ag$_2$(MoO$_4$)$_3$ composite ceramics. The larger grain size of the Al observed is due to the larger particle size of the Al initially used.

To understand the effect of Ag$_2$O on the properties of CMO, the properties of CMO composite ceramics sintered at 500 °C is compared to that of pure CMO (Table 2). It is evident that relative permittivity, $\tau_f$ and CTE of the CMO were not affected much by the Ag$_2$O addition while Qf decreases
with increase in Ag₂O addition. These composites can be accounted from the application point of view, considering the lowering of sintering temperature achieved along with good dielectric and thermal properties. Table 3 compares the microwave dielectric properties of some low sintering temperature materials (400-500 °C) with relative permittivity around 8 [17, 54, 55, 65]. The results indicate that Ag₂O doped CMO can serve as a potential candidate for ULTCC applications owing to its low sintering temperature with good densification while keeping the good dielectric and thermal properties.

Conclusions

Ultra-low temperature cofired ceramic composites with sintering temperature of 500 °C, and good densification of 96 % was achieved by adding CuMoO₄ with a small amount of Ag₂O by simple mixing method. The effect of addition on the microstructure, sintering, densification, thermal and microwave dielectric properties was investigated. The reduction in the sintering temperature is due to the formation of trace amount of copper silver molybdate (Cu₂Ag₂(MoO₄)₃ ) of about 1.4% as observed from Rietveld refinement analysis as well as backscattered SEM image. It was observed, that the Ag₂O doping has very little effect on the structure and the thermal expansion, which was 5 ppm/ °C. The doping has influence on the microwave dielectric properties especially the quality factor. The Ag₂O added (0.5, 1 and 2 wt.%) samples exhibit εr, Qf and τf in the range of 8-9, 37000-26000 GHz at about 12 GHz and -31 to -33 ppm/ °C, respectively. The CMO-Cu₂Ag₂(MoO₄)₃ composite ceramics are found to be compatible with Al electrode. The present work results in obtaining composites with different dielectric properties and good thermal properties at very low sintering temperature without much affecting the structure by small doping, which are useful for multilayer packages and substrates and can be applicable for other high temperature ceramics with good properties. Hence, CuMoO₄-Cu₂Ag₂(MoO₄)₃ composite ceramics with good densification, thermal and dielectric properties can be used as a promising material for various practical ULTCC applications.
Acknowledgement

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### Tables

**Table 1** Refined lattice parameters

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<tr>
<th>Lattice parameters</th>
<th>CuMoO₄</th>
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<tr>
<td>a (Å)</td>
<td>6.7876 (0.00017)</td>
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<tr>
<td>b (Å)</td>
<td>8.3734 (0.00021)</td>
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<tr>
<td>c (Å)</td>
<td>9.9056 (0.00025)</td>
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<tr>
<td>Volume (Å³)</td>
<td>518.8670 (0.0232)</td>
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<td>Quantitative value (%)</td>
<td>98.6165 (0.4055)</td>
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<td>Space group</td>
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**Table 2** Comparison of the properties of pure and Ag₂O doped CMO

<table>
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<th>Properties</th>
<th>CMO [43]</th>
<th>Ag₂O doped CMO (wt. %)</th>
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<tr>
<td></td>
<td></td>
<td>0.5</td>
</tr>
<tr>
<td>S.T°(°C)</td>
<td>650</td>
<td>500</td>
</tr>
<tr>
<td>Densification (%)</td>
<td>96</td>
<td>96.0</td>
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<tr>
<td>Qf (GHz)</td>
<td>53000</td>
<td>37000</td>
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<tr>
<td>ε_r</td>
<td>7.9</td>
<td>8.0</td>
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<tr>
<td>Porosity corrected ε_r #</td>
<td>8.4</td>
<td>8.5</td>
</tr>
<tr>
<td>τf (ppm/°C)</td>
<td>-36</td>
<td>-32</td>
</tr>
<tr>
<td>CTE (ppm/°C)</td>
<td>4.6</td>
<td>4.7</td>
</tr>
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# S.T.: Sintering Temperature

**Table 3** Comparison of microwave dielectric properties of some low sintering temperature dielectric ceramics (400-500 °C)

<table>
<thead>
<tr>
<th>Composition</th>
<th>S.T°(°C)</th>
<th>ε_r</th>
<th>Qf (GHz)</th>
<th>τf (ppm/°C)</th>
<th>Reactivity with Ag or Al</th>
<th>Ref.</th>
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<tr>
<td>NaAgMoO₄</td>
<td>400</td>
<td>7.9</td>
<td>33000</td>
<td>-120</td>
<td>-</td>
<td>54</td>
</tr>
<tr>
<td>(Na₁.₂Ag₀.₈)MoO₄</td>
<td>410</td>
<td>8.1</td>
<td>44800</td>
<td>-82</td>
<td>-</td>
<td>55</td>
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<tr>
<td>Ag₂MoO₄</td>
<td>450</td>
<td>8.1</td>
<td>17000</td>
<td>-133</td>
<td>-</td>
<td>65</td>
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<tr>
<td>K₂Mo₂O₇</td>
<td>460</td>
<td>7.5</td>
<td>22300</td>
<td>-63</td>
<td>Yes for Ag, no for Al</td>
<td>17</td>
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<tr>
<td>CMO-0.5 Ag₂O</td>
<td>500</td>
<td>8.0</td>
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<td>-32</td>
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<tr>
<td>CMO-1 Ag₂O</td>
<td>500</td>
<td>8.3</td>
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<td>500</td>
<td>8.8</td>
<td>26000</td>
<td>-33</td>
<td>Yes for Ag, no for Al</td>
<td>This work</td>
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& S.T.: Sintering Temperature
Figure captions

Figure 1 X-ray powder diffraction pattern of pure CMO and Ag₂O (0.5, 1, 2 wt% ) added CMO sintered at 500 °C.

Figure 2 (a) Slow scan X-ray powder diffraction pattern and Rietveld refinement results, (b) refinement fitness and (c) back scattered electron image of 0.5 wt % Ag₂O added CMO sintered at 500 °C.

Figure 3 (a) Bulk density and (b) densification of CMO composite ceramics with sintering temperature in the range of 350 - 550 °C.

Figure 4 Microstructure (SE2 image) of CMO doped with Ag₂O (a) 0.5 (b) 1 (c) 2 wt.% sintered at 450 °C, (d) 0.5 (e) 1 (f) 2 wt.% sintered at 500 °C, (g) 0.5 (h) 1 (i) 2 wt.% sintered at 550 °C.

Figure 5 Thermal expansion of CMO composite ceramics sintered at 500 °C in the temperature range of 25 - 300 °C.

Figure 6 (a) εᵣ and (b) Qf of CMO composite ceramics as a function of sintering temperature at 12 GHz.

Figure 7 Variation of resonant frequency of CMO composite ceramics sintered at 500 °C as a function of temperature.

Figure 8 (a) XRD (b) Back scattered electron images of 2 wt.% Ag₂O added CMO with 50 wt.% of Al cofired at 500 °C.
Figures

Figure 1
Figure 2

(b) Refinement parameters

<table>
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<td>$R_{wp}$</td>
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<tr>
<td>$R_p$</td>
<td>3.88 %</td>
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<tr>
<td>$R_e$</td>
<td>3.96 %</td>
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<tr>
<td>$S$</td>
<td>1.3073</td>
</tr>
<tr>
<td>$\chi^2$</td>
<td>1.7089</td>
</tr>
<tr>
<td>Maximum shift/e.s.d.</td>
<td>1.627</td>
</tr>
</tbody>
</table>
Figure 3
Figure 6
Figure 7

Figure 8